

# ANALOG DEVICES EVAL-ADPA9007 2 W Power Amplifier User Guide

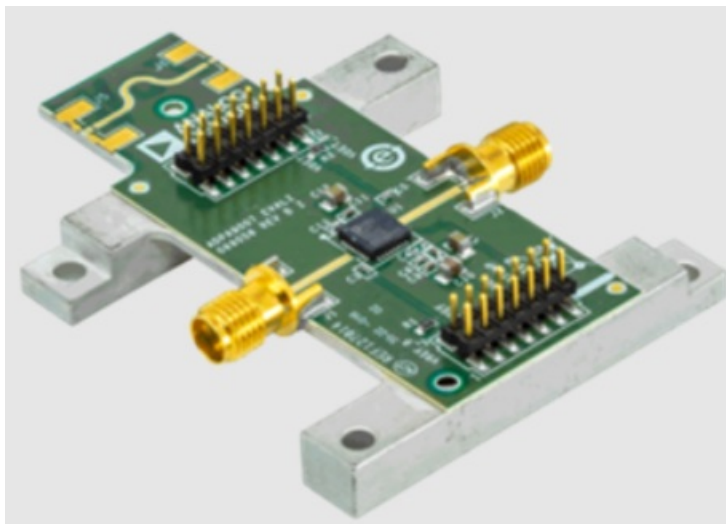
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## ANALOG DEVICES EVAL-ADPA9007 2 W Power Amplifier



## Specifications

- Frequency Range: DC to 28 GHz
- Technology: GaAs pHEMT
- Power Output: 2 W
- Evaluation Board: 2-layer Rogers 4350B with heat spreader
- Connectors: End launch 2.92 mm RF connectors

## Operating the ADPA9007-EVALZ

The DC connections required to operate the EVAL-ADPA9007 are accessed through the J3 and J4 header pins. Refer to Table 1 for pin descriptions. Figure 3 shows the connections necessary to operate the EVAL-ADPA9007.

## FAQ

### Q: What equipment is needed for operating the EVAL-ADPA9007?

A: You will need an RF signal generator, RF spectrum analyzer, RF network analyzer, 15 V, 1.0 A power supply, 0 V to -2.0 V, 10 mA power supply, 5 V, 100 mA power supply, DC block, Bias tee, 5 W attenuator, and a 10 dB attenuator.

## Evaluating the ADPA9007 DC to 28 GHz, GaAs, pHEMT, 2 W Power Amplifier

## FEATURES

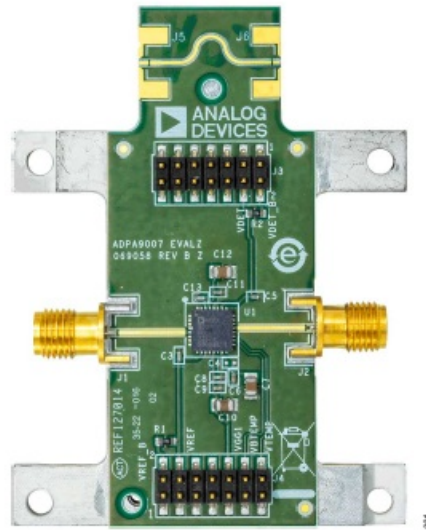
- 2-layer Rogers 4350B evaluation board with heat spreader
- End launch 2.92 mm RF connectors
- Through calibration path

## EVALUATION KIT CONTENTS

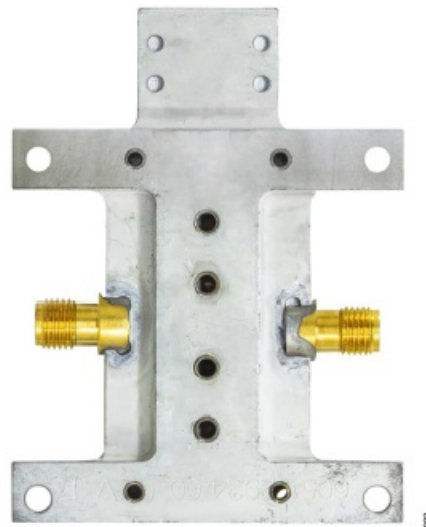
- 2-layer Rogers 4350B, EVAL-ADPA9007 evaluation board with heat spreader

## EQUIPMENT NEEDED

- RF signal generator
- RF spectrum analyzer
- RF network analyzer
- 15 V, 1.0 A power supply
- 0 V to -2.0 V, 10 mA power supply
- 5 V, 100 mA power supply
- DC block, Marki Microwave, DCZM29F29 or equivalent
- Bias tee, Marki Microwave, BT20050 or equivalent
- 5 W attenuator  $\geq 10$  dB



**Figure 1. Primary Side**



**Figure 2. Secondary Side**

## GENERAL DESCRIPTION

- The EVAL-ADPA9007 consists of a 2-layer printed circuit board (PCB) fabricated from 10 mil thick Rogers 4350B copper clad mounted to an aluminum heat spreader. The heat spreader assists in providing thermal relief to the ADPA9007 and mechanical support to the PCB. The mounting holes on the heat spreader allow for attachment to larger heat sinks to improve thermal management.
- The RFIN and RFOUT/VDD ports are populated by 2.92 mm female coaxial connectors, and the respective RF traces are of 50  $\Omega$  characteristic impedance. The EVAL-ADPA9007 is populated with components suitable for use over the entire operating temperature range of the ADPA9007.
- The RF transmission lines are 50  $\Omega$  grounded coplanar waveguides.
- The package ground leads and the exposed pad connect directly to the ground plane. Multiple vias are used to connect the top and bottom ground planes, with particular focus on the area directly beneath the ground paddle, to provide adequate electrical conduction and thermal conduction to the heat spreader.
- The power supply decoupling capacitors shown in the Figure 5 represent the configuration used in characterizing the device. Full details about the part are available in the ADPA9007 data sheet, which must be consulted when using the EVAL-ADPA9007.

## REVISION HISTORY

## OPERATING THE

### ADPA9007-EVALZ

The DC connections required to operate the EVAL-ADPA9007 are accessed through the J3 and J4 header pins (see Table 1 for pin descriptions). Figure 3 shows the connections necessary to operate the EVAL-ADPA9007. The on-chip temperature monitor provides a voltage that is proportional to the temperature. To use this feature, apply +5 V to the VBTEMP pin and monitor the corresponding voltage on the VTEMP pin. User calibration is required.

An on-chip power monitor is provided to allow for convenient monitoring of the power present at the output of the ADPA9007. To use this feature, apply +5 V to VDET\_B and VREF\_B and monitor the voltage on the VREF pin and the VDET pin. The temperature-compensated voltage proportional to the ADPA9007 output power is ( $VREF - VDET$ ). User calibration is required when using this feature.

### POWER-UP SEQUENCE

Take the following steps to power up:

1. Set the VGG1 pin (Pin 10 of J4) to  $-2$  V.
2. Set the RFOUT/VDD pin to +15 V through an external bias tee.
3. Adjust the VGG1 pin between  $-2$  V and 0 V to achieve a quiescent drain current of 500 mA.
4. To operate the on-chip temperature monitor and on-chip power detectors, apply +5 V to the VREF\_B, VBTEMP, and VDET\_B pins (Pin 2 and 12 of J4 and Pin 2 of J3).
5. Apply the RF signal to the RFIN connector of the EVAL-AD-PA9007.

### POWER-DOWN SEQUENCE

Take the following steps to power down:

1. Turn off the RF signal
2. Set the gate voltage (VGG1) to  $-2$  V
3. Set the supply voltage (VDD) to 0 V
4. Set the VREF\_B, VBTEMP, and VDET\_B pins to 0 V
5. Increase the VGG1 pin to 0 V

Table 1. J3 and J4 Header Connections to the ADPA9007

|                       |                   |
|-----------------------|-------------------|
| J3                    |                   |
| 1, 3, 5, 7, 9, 11, 13 | GND               |
| 2                     | VDET_B            |
| 4                     | VDET              |
| 6, 8, 10, 12, 14      | Open (do not use) |
| J4                    |                   |
| 1, 3, 5, 7, 9, 11, 13 | GND               |
| 2                     | VREF_B            |
| 4                     | VREF              |
| 6, 8                  | Open (do not use) |
| 10                    | VGG1              |
| 12                    | VBTEMP            |
| 14                    | VTEMP             |

## OPERATING THE ADPA9007-EVALZ

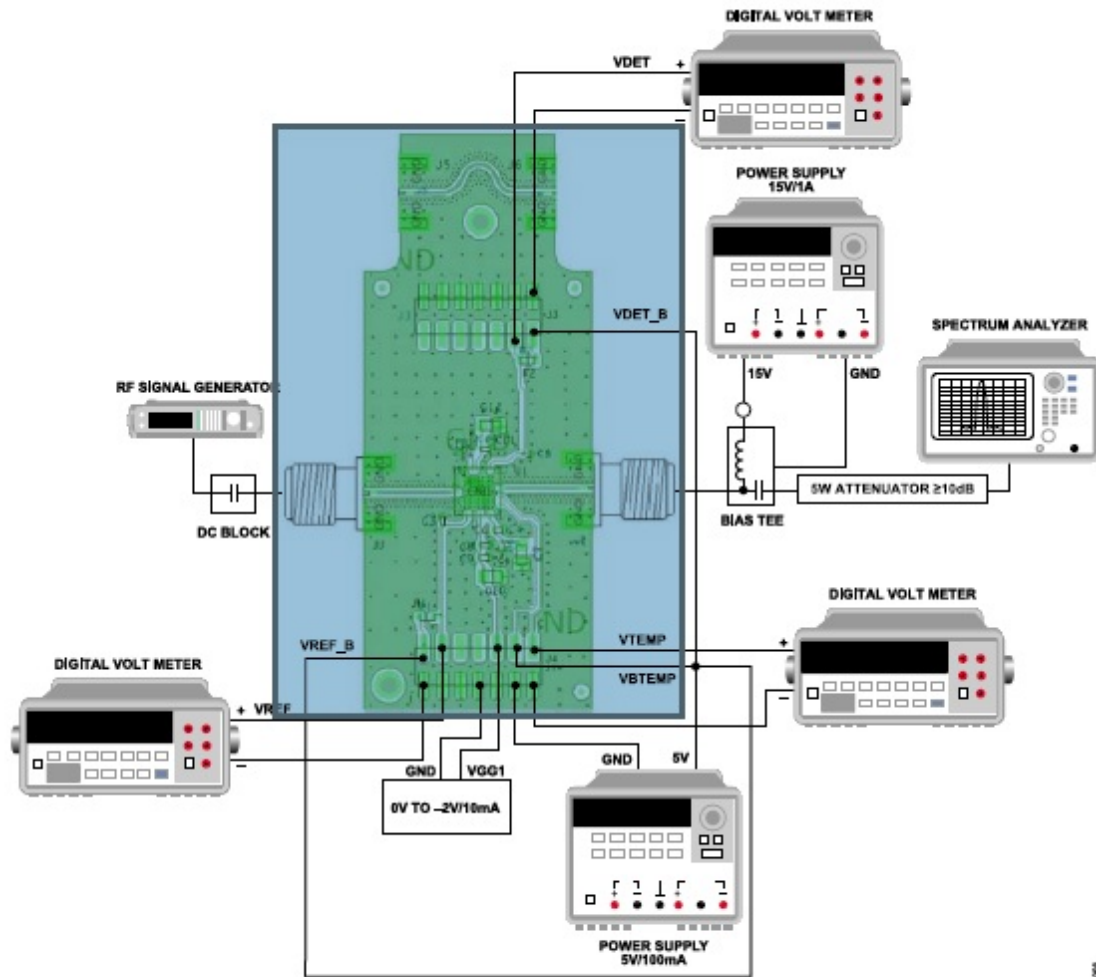


Figure 3. Operation Connections

## THROUGH CALIBRATION PATH

To calibrate out board trace losses, a through calibration path is provided. J5 and J6 must be populated with 2.92 mm RF connectors to use the through calibration path.

Figure 4 shows the plot of the data in Table 2 of the through calibration path (J5 to J6). See Figure 5 for the evaluation board schematic.

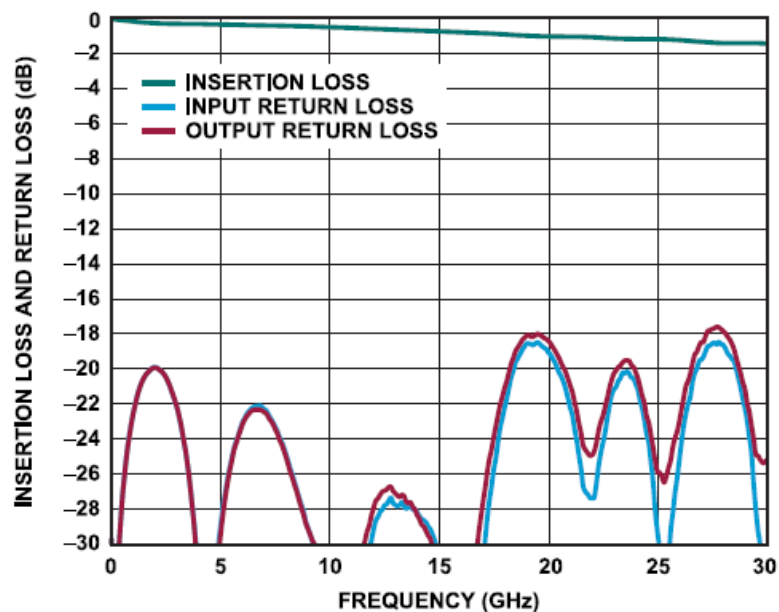


Figure 4. Insertion Loss of Through Calibration Path

**Table 2. Insertion Loss of Through Calibration Path**

|      |       |
|------|-------|
| 0.01 | −0.05 |
| 0.5  | −0.10 |
| 1    | −0.17 |
| 2    | −0.27 |
| 5    | −0.35 |
| 10   | −0.51 |
| 15   | −0.74 |
| 20   | −1.03 |
| 25   | −1.19 |
| 28   | −1.41 |
| 30   | −1.44 |

**EVALUATION BOARD SCHEMATIC AND ARTWORK**

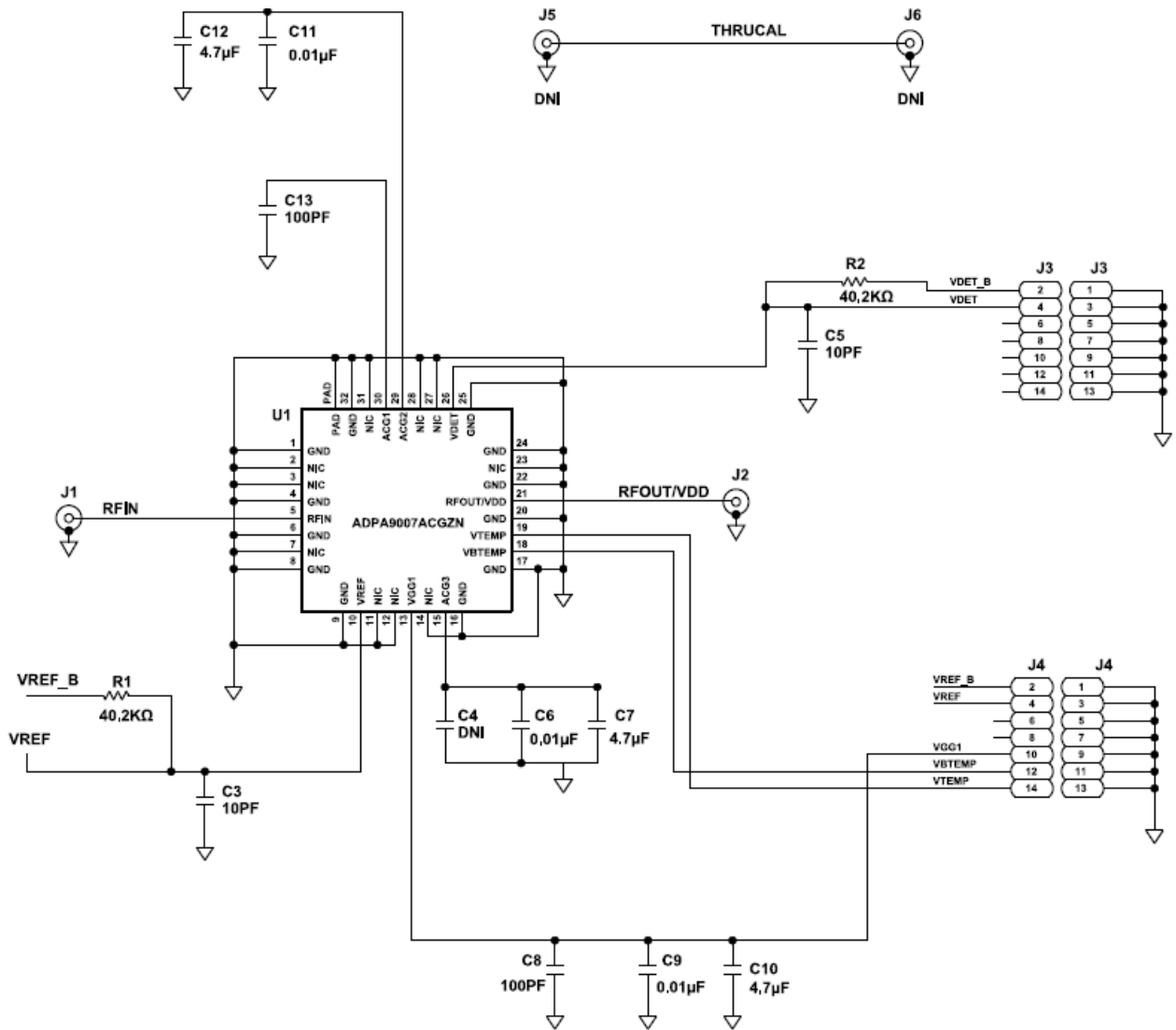


Figure 5. ADPA9007-EVALZ Evaluation Board Schematic

## EVALUATION BOARD SCHEMATIC AND ARTWORK

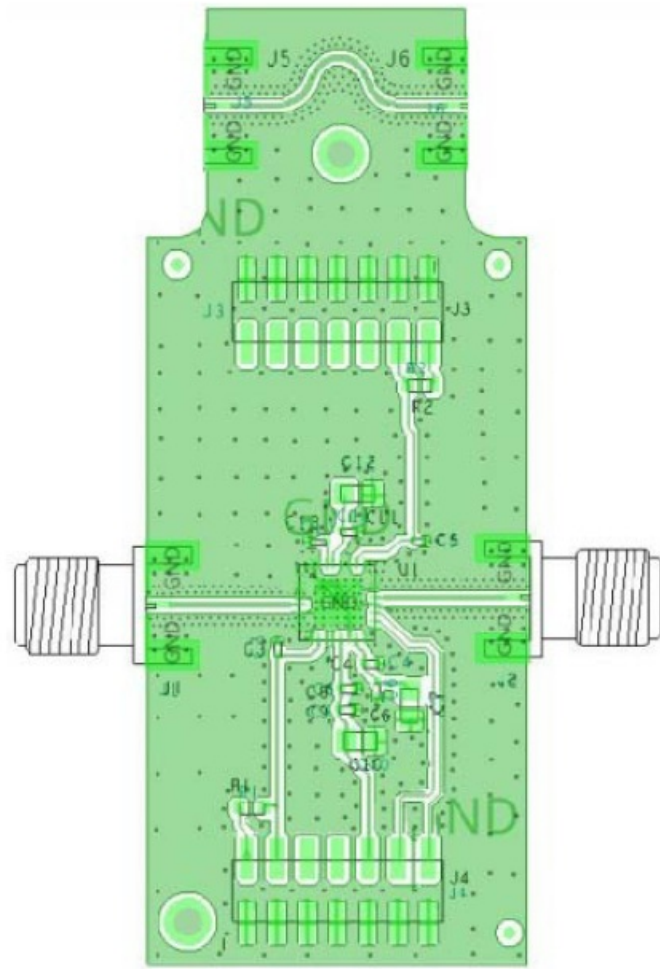


Figure 6. ADPA9007-EVALZ Assembly Drawing (J5 and J6 Are Not Installed)

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## ORDERING INFORMATION

## BILL OF MATERIALS

Table 3.

|                |  |                         |                               |
|----------------|--|-------------------------|-------------------------------|
| C7, C10, C12   | Ceramic capacitors, 4.7 $\mu$ F, 50 V, 10%, X5R, 0805, low effective series resistance   | TDK Corporation         | C2012X5R1H475K125AB           |
| C6, C9, C11    | Ceramic capacitors, 0.01 $\mu$ F, 25 V, 10%, X7R, 0402                                   | KEMET Corporation       | C0402C103K3RACTU              |
| C8, C13        | Ceramic capacitors, 100 pF, 50 V, 5%, C0G, 0402  | YAGEO                   | CC0402JRNPO9B N101            |
| C3, C5         | Ceramic capacitors, 10 pF, 50 V, 5%, C0G, 0402   | Johanson Dielectrics    | 500R07N100JV4T                |
| J1, J2         | Edge launch jack connectors  | Winchester Interconnect | 25-146-1000-92                |
| J3, J4         | PCB connection header, 2 mm pitch, dual row with peg, 0.5 mm square post and 3.8 mm long | Molex                   | 87759-1450                    |
| U1             | GaAs, pHEMT, 2 W, DC to 28 GHz power amplifier   | Analog Devices, Inc.    | <a href="#">ADPA9007ACGZN</a> |
| C4             | Ceramic capacitor, 100 pF, 50 V, 5%, C0G, 0402 (not installed)                           | YAGEO                   | CC0402JRNPO9B N101            |
| J5, J6         | Edge launch jack connectors (not installed)  | Winchester Interconnect | 25-146-1000-92                |
| R1, R2         | Resistors, 40.2 k $\Omega$ , 1%, 1/10 W 0603 AEC-Q200                                    | Vishay                  | CRCW060340K2FKEA              |
| Not applicable | Aluminum heat spreader, 2.51 in $\times$ 1.9 in  | Not applicable          | Not applicable                |

### ESD Caution

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

### Legal Terms and Conditions


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## Documents / Resources

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|---|---|
|  | <p><a href="#">ANALOG DEVICES EVAL-ADPA9007 2 W Power Amplifier</a> [pdf] User Guide<br/>EVAL-ADPA9007 2 W Power Amplifier, EVAL-ADPA9007 2 W, Power Amplifier, Amplifier</p> |
|---|---|

## References

- [User Manual](#)

[Manuals+](#). [Privacy Policy](#)

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